

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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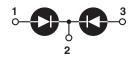
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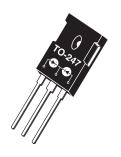








- 1 Anode 1
- 2 Common Cathode Back of Case - Cathode
- 3 Anode 2





### APT15D120BCT 1200V 15A APT15D120BCTG 1200V 15A

\*G Denotes RoHS Compliant, Pb Free Terminal Finish.

## **ULTRAFAST SOFT RECOVERY RECTIFIER DIODE**

PRODUCT APPLICATIONS	PRODUCT FEATURES	PRODUCT BENEFITS
Anti-Parallel Diode     Switchmands Bower Swarphy	<ul> <li>Ultrafast Recovery Times</li> </ul>	Low Losses
<ul><li>-Switchmode Power Supply -Inverters</li></ul>	Soft Recovery Characteristics	<ul> <li>Low Noise Switching</li> </ul>
Free Wheeling Diode     -Motor Controllers	Popular TO-247 Package or Surface Mount D³PAK Package	Cooler Operation
-Converters  • Snubber Diode	Low Forward Voltage	<ul> <li>Higher Reliability Systems</li> </ul>
<ul><li>Uninterruptible Power Supply (UPS)</li><li>Induction Heating</li></ul>	High Blocking Voltage	<ul> <li>Increased System Power Density</li> </ul>
High Speed Rectifiers	<ul> <li>Low Leakage Current</li> </ul>	20

### **MAXIMUM RATINGS** All Ratings: $T_C = 25^{\circ}C$ unless otherwise specified.

Symbol	Characteristic / Test Conditions	APT15D120BCT(G)	UNIT
$V_R$	Maximum D.C. Reverse Voltage		
V <sub>RRM</sub>	Maximum Peak Repetitive Reverse Voltage	1200	Volts
V <sub>RWM</sub>	Maximum Working Peak Reverse Voltage		
I <sub>F</sub> (AV)	Maximum Average Forward Current (T <sub>C</sub> = 98°C, Duty Cycle = 0.5)	15	
I <sub>F</sub> (RMS)	RMS Forward Current (Square wave, 50% duty)	24	Amps
I <sub>FSM</sub>	Non-Repetitive Forward Surge Current (T <sub>J</sub> = 45°C, 8.3ms)	110	
$T_J, T_STG$	Operating and StorageTemperature Range	-55 to 150	°C
T <sub>L</sub>	Lead Temperature for 10 Sec.	300	

#### STATIC ELECTRICAL CHARACTERISTICS

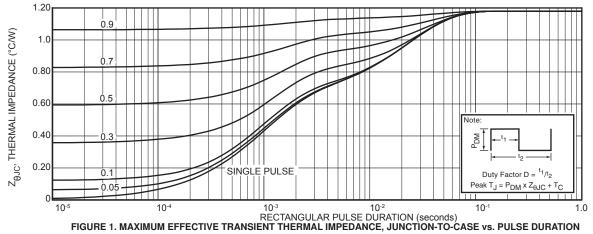
Symbol			MIN	TYP	MAX	UNIT
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 15A		2.0	2.5	
		I <sub>F</sub> = 30A		2.3		Volts
		I <sub>F</sub> = 15A, T <sub>J</sub> = 125°C		1.8		
I <sub>RM</sub> Max	Maximum Reverse Leakage Current	$V_R = V_R$ Rated			250	μA
		$V_R = V_R$ Rated, $T_J = 125$ °C			500	μΛ
C <sub>T</sub>	Junction Capacitance, V <sub>R</sub> = 200V			17		pF

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
t <sub>rr</sub>	Reverse Recovery Time $I_F = 1A$ , $di_F/dt = -100A/\mu s$ , $V_R = 30V$ , $T_J = 25^{\circ}C$		-	32		ns
t <sub>rr</sub>	Reverse Recovery Time	$I_F = 15A$ , $di_F/dt = -200A/\mu s$ $V_R = 800V$ , $T_C = 25^{\circ}C$	ı	260		113
Q <sub>rr</sub>	Reverse Recovery Charge		-	480		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current		ı	4	-	Amps
t <sub>rr</sub>	Reverse Recovery Time	$I_F = 15A$ , $di_F/dt = -200A/\mu s$ $V_R = 800V$ , $T_C = 125$ °C	ı	370		ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	1300		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current		-	9	-	Amps
t <sub>rr</sub>	Reverse Recovery Time	$I_F = 15A$ , $di_F/dt = -1000A/\mu s$ $V_R = 800V$ , $T_C = 125^{\circ}C$	-	140		ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	2000		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current		- 1	28		Amps

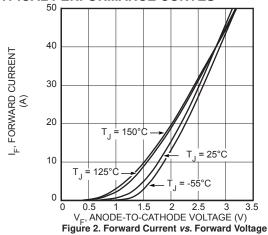
#### THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction-to-Case Thermal Resistance			1.18	°C/W
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance			40	
W <sub>T</sub> Package	Packago Wojaht		0.22		OZ
	i ackage weight		5.9		g
Torque	Maximum Mounting Torque			10	lb•in
				1.1	N•m

Microsemi Reserves the right to change, without notice, the specifications and information contained herein.



#### **TYPICAL PERFORMANCE CURVES**



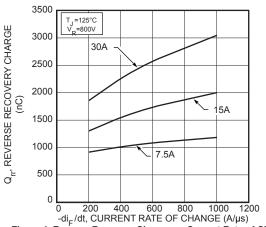
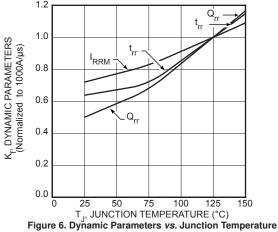


Figure 4. Reverse Recovery Charge vs. Current Rate of Change



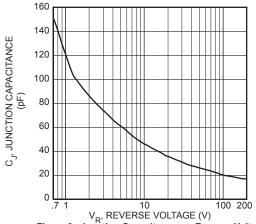


Figure 8. Junction Capacitance vs. Reverse Voltage

#### APT15D120BCT(G)

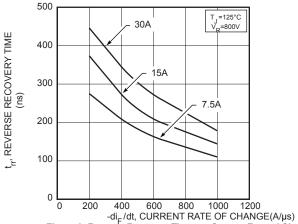


Figure 3. Reverse Recovery Time vs. Current Rate of Change

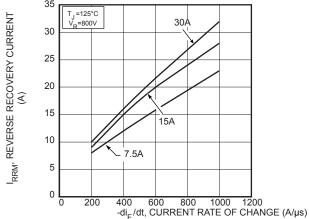


Figure 5. Reverse Recovery Current vs. Current Rate of Change

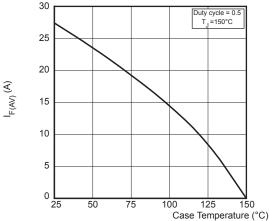
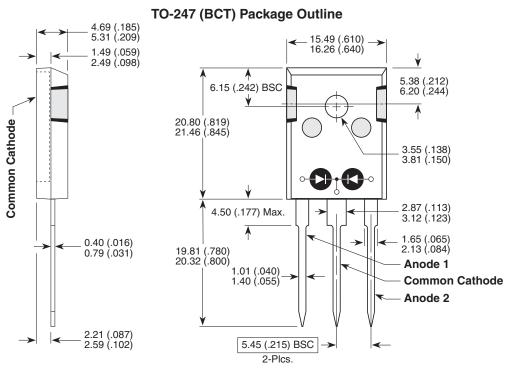


Figure 7. Maximum Average Forward Current vs. CaseTemperature

Figure 9. Diode Test Circuit

- 1 I<sub>F</sub> Forward Conduction Current
  2 di<sub>F</sub>/dt Rate of Diode Current Change Through Zero Crossing.
  3 I<sub>RRM</sub> Maximum Reverse Recovery Current.
  4 t<sub>rr</sub> Reverse Recovery Time, measured from zero crossing where diode current goes from positive to negative, to the point at which the straight line through I<sub>RRM</sub> and 0.25 •I<sub>RRM</sub> passes through zero.
- $\mathbf{5}$  Q<sub>rr</sub> Area Under the Curve Defined by I<sub>RRM</sub> and t<sub>rr</sub>.

Figure 10, Diode Reverse Recovery Waveform and Definitions



Dimensions in Millimeters and (Inches)